



Vincotech

| flowBOOST 2 dual | | 1200 V / 200 A |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|-----------------------------|
| Topology features | | |
| <ul style="list-style-type: none">• Auxiliary diodes for FC pre-charge (patent pending)• Dual Flying Cap Booster• Kelvin Emitter for improved switching performance• Temperature sensor | | |
| Component features | | flow 2 13 mm housing |
| <ul style="list-style-type: none">• High speed switching• Low collector emitter saturation voltage• Low turn-off losses• Optimized for hard switching topologies• Positive temperature coefficient | | |
| Housing features | | |
| <ul style="list-style-type: none">• Base isolation: Al₂O₃• Convex shaped baseplate for superior thermal contact• Cu baseplate• Thermo-mechanical push-and-pull force relief• Solder pin | | |
| Target applications | | Schematic |
| <ul style="list-style-type: none">• Energy Storage Systems• Solar Inverters | | |
| Types | | |
| <ul style="list-style-type: none">• 30-FT12B2A200H705-PK49L06 | | |



30-FT12B2A200H705-PK49L06

datasheet

Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-----------------------------------|------------|------------------------------------------------------|----------|------------------|
| Inner Boost Switch | | | | |
| Collector-emitter voltage | V_{CES} | | 1200 | V |
| Collector current (DC current) | I_C | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 156 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 600 | A |
| Turn off safe operating area | | $T_j = 150^\circ\text{C}$, $V_{CE} = 1200\text{ V}$ | 600 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 287 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Maximum junction temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Inner Boost Diode

| | | | | |
|----------------------------------------|------------|--------------------------------------------------------------------------|------|------------------|
| Peak repetitive reverse voltage | V_{RRM} | | 1200 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 114 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 204 | A |
| Surge (non-repetitive) forward current | I_{FSM} | Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 110^\circ\text{C}$ | 516 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 231 | W |
| Maximum junction temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Inner Boost Sw. Protection Diode

| | | | | |
|----------------------------------------|------------|--------------------------------------------------------------------------|------|----------------------|
| Peak repetitive reverse voltage | V_{RRM} | | 1600 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 78 | A |
| Surge (non-repetitive) forward current | I_{FSM} | Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150^\circ\text{C}$ | 480 | A |
| Surge current capability | I^t | | 1100 | A^2s |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 92 | W |
| Maximum junction temperature | T_{jmax} | | 150 | $^\circ\text{C}$ |



Vincotech

Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-----------------------------------|------------|------------------------------------------------------|----------|------------------|
| Outer Boost Switch | | | | |
| Collector-emitter voltage | V_{CES} | | 1200 | V |
| Collector current (DC current) | I_C | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 156 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 600 | A |
| Turn off safe operating area | | $T_j = 150^\circ\text{C}$, $V_{CE} = 1200\text{ V}$ | 600 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 287 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Maximum junction temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Outer Boost Diode

| | | | | |
|----------------------------------------|------------|--------------------------------------------------------------------------|------|------------------|
| Peak repetitive reverse voltage | V_{RRM} | | 1200 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 114 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 204 | A |
| Surge (non-repetitive) forward current | I_{FSM} | Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 110^\circ\text{C}$ | 516 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 231 | W |
| Maximum junction temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Outer Boost Sw. Protection Diode

| | | | | |
|----------------------------------------|------------|--------------------------------------------------------------------------|------|----------------------|
| Peak repetitive reverse voltage | V_{RRM} | | 1600 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 78 | A |
| Surge (non-repetitive) forward current | I_{FSM} | Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150^\circ\text{C}$ | 480 | A |
| Surge current capability | I^t | | 1100 | A^2s |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$ | 92 | W |
| Maximum junction temperature | T_{jmax} | | 150 | $^\circ\text{C}$ |



30-FT12B2A200H705-PK49L06

datasheet

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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|----------------------------------------|------------|-----------------------------------------|-------|------------------|
| Aux Diode H | | | | |
| Peak repetitive reverse voltage | V_{RRM} | | 1200 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ | 74 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 150 | A |
| Surge (non-repetitive) forward current | I_{FSM} | Single Half Sine Wave, $t_p = 10$ ms | 600 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ | 145 | W |
| Maximum junction temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Aux Diode L

| | | | | |
|----------------------------------------|------------|-----------------------------------------|------|------------------|
| Peak repetitive reverse voltage | V_{RRM} | | 1200 | V |
| Forward current (DC current) | I_F | $T_j = T_{jmax}$ | 74 | A |
| Repetitive peak forward current | I_{FRM} | t_p limited by T_{jmax} | 150 | A |
| Surge (non-repetitive) forward current | I_{FSM} | Single Half Sine Wave, $t_p = 10$ ms | 600 | A |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ | 145 | W |
| Maximum junction temperature | T_{jmax} | | 175 | $^\circ\text{C}$ |

Module Properties

Thermal Properties

| | | | | |
|-------------------------------------------------|-----------|--|----------------------------|------------------|
| Storage temperature | T_{stg} | | -40...+125 | $^\circ\text{C}$ |
| Operation temperature under switching condition | T_{jop} | | -40...+($T_{jmax} - 25$) | $^\circ\text{C}$ |

Isolation Properties

| | | | | | |
|----------------------------|------------|------------------|-------------|------------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* | $t_p = 2$ s | 6000 | V |
| Creepage distance | | | | >12,7 | mm |
| Clearance | | | | >12,7 | mm |
| Comparative Tracking Index | CTI | | | ≥ 600 | |

*100 % tested in production



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------------------------|-------------------------------------------|-------------------------------------|------------|-----|--------|-----|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |

Inner Boost Switch

Static

| | | | | | | | | | | |
|--------------------------------------|---------------|-------------------|------|------|--------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,0032 | 25 | 4,7 | 5,5 | 6,2 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 200 | 25 125 150 | | 1,78 1,94 1,98 | 2,15 ⁽¹⁾ | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 1200 | | 25 | | | 8 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 200 | nA |
| Internal gate resistance | r_g | | | | | | | None | | Ω |
| Input capacitance | C_{res} | $f = 100$ kHz | 0 | 25 | 25 | 25 | | 26000 | | pF |
| Output capacitance | C_{ces} | | | | | | | 480 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 144 | | pF |
| Gate charge | Q_g | $V_{CC} = 960$ V | 0/15 | | 200 | 25 | | 1428 | | nC |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,33 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|-----------------------------------------------|----------|-----|-----|-----|--|--------|--------|----|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$ | ± 15 | 700 | 200 | 25 | | 157,6 | 160,68 | ns |
| Rise time | t_r | | | | | 125 | | 12,43 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 150 | | 13,97 | | |
| Fall time | t_f | | | | | 25 | | 14,06 | | |
| Turn-on energy (per pulse) | E_{on} | | | | | 125 | | 172,21 | | |
| Turn-off energy (per pulse) | E_{off} | | | | | 150 | | 205,54 | | |
| | | | | | | 25 | | 214,87 | | |
| | | | | | | 125 | | 44,81 | | |
| | | | | | | 150 | | 65,58 | | |
| | | | | | | 25 | | 72,71 | | |
| | | | | | | 125 | | 4,03 | mWs | ns |
| | | | | | | 150 | | 4,38 | | |
| | | | | | | 25 | | 4,32 | | |
| | | | | | | 125 | | 6,66 | mWs | ns |
| | | | | | | 150 | | 9,8 | | |
| | | | | | | 25 | | 10,72 | | |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|-----------|------------|--------|-----|-----|------|
| | | V_{GE} [V] | V_{GS} [V] | V_{CE} [V] | V_{DS} [V] | I_C [A] | T_j [°C] | Min | Typ | Max | |

Inner Boost Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|----------------|--|--|----|------------------|--|----------------------|------------------|----|
| Forward voltage | V_F | | | | 80 | 25 125 150 | | 1,37 1,56 1,63 | 2 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_r = 1200$ V | | | | 25 | | 20 | 2000 | µA |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,41 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|----------------------------------------------------------------|----------|-----|-----|-----|--|----------|--|------|
| Peak recovery current | I_{RM} | $di/dt=11054$ A/µs $di/dt=10367$ A/µs $di/dt=10213$ A/µs | ± 15 | 700 | 200 | 25 | | 74,88 | | |
| Reverse recovery time | t_{rr} | | | | | 125 | | 77,51 | | A |
| Recovered charge | Q_r | | | | | 150 | | 79,69 | | |
| Reverse recovered energy | E_{rec} | | 25 | | | 25 | | 21,93 | | |
| Reverse recovered energy | E_{rec} | | 125 | | | 125 | | 18,21 | | ns |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | | 150 | | | 150 | | 18,07 | | |
| | | | | | | 25 | | 0,777 | | |
| | | | | | | 125 | | 0,74 | | µC |
| | | | | | | 150 | | 0,745 | | |
| | | | | | | 25 | | 0,183 | | |
| | | | | | | 125 | | 0,162 | | mWs |
| | | | | | | 150 | | 0,163 | | |
| | | | | | | 25 | | 8445,01 | | |
| | | | | | | 125 | | 9338,74 | | |
| | | | | | | 150 | | 10185,06 | | A/µs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|-----------|-----------|------------|-----|------|
| | | V_{GE} [V] | V_{GS} [V] | V_{CE} [V] | V_{DS} [V] | I_C [A] | I_D [A] | T_j [°C] | Min | |

Inner Boost Sw. Protection Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|----------------|--|--|----|------------------|--|------------------------|--------------------|----|
| Forward voltage | V_F | | | | 40 | 25 125 150 | | 1,06 0,987 0,974 | 1,5 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_T = 1600$ V | | | | 25 150 | | | 100 2000 | µA |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,76 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|-----------|------------|-----|-----|------|
| | | V_{GE} [V] | V_{GS} [V] | V_{CE} [V] | V_{DS} [V] | I_C [A] | T_j [°C] | Min | Typ | |

Outer Boost Switch

Static

| | | | | | | | | | | |
|--------------------------------------|---------------|-------------------|------|------|--------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}$ | | | 0,0032 | 25 | 4,7 | 5,5 | 6,2 | V |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | | 15 | | 200 | 25 125 150 | | 1,78 1,94 1,98 | 2,15 ⁽¹⁾ | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 1200 | | 25 | | | 8 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 | | | 200 | nA |
| Internal gate resistance | r_g | | | | | | | None | | Ω |
| Input capacitance | C_{res} | $f = 100$ kHz | 0 | 25 | 25 | 25 | | 26000 | | pF |
| Output capacitance | C_{ces} | | | | | | | 480 | | pF |
| Reverse transfer capacitance | C_{res} | | | | | | | 144 | | pF |
| Gate charge | Q_g | $V_{CC} = 960$ V | 0/15 | | 200 | 25 | | 1428 | | nC |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,33 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|-----------------------------|--------------|----------------------------------------------------------------------------|----------|-----|-----|-----|--|--------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$ | ± 15 | 700 | 200 | 25 | | 153,76 | | |
| Rise time | t_r | | | | | 125 | | 156,72 | | ns |
| | | | | | | 150 | | 157,81 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 | | 14,8 | | |
| | | | | | | 125 | | 16,6 | | |
| Fall time | t_f | | | | | 150 | | 17,05 | | ns |
| Turn-on energy (per pulse) | E_{on} | $Q_{tFWD}=0,725 \mu C$ $Q_{fFWD}=0,736 \mu C$ $Q_{ffwd}=0,747 \mu C$ | | | | 25 | | 168,41 | | |
| | | | | | | 125 | | 202,16 | | |
| | | | | | | 150 | | 211,65 | | |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 | | 34,56 | | |
| | | | | | | 125 | | 59,01 | | |
| | | | | | | 150 | | 68,41 | | ns |
| | | | | | | 25 | | 3,38 | | |
| | | | | | | 125 | | 3,56 | | |
| | | | | | | 150 | | 3,51 | | mWs |
| | | | | | | 25 | | 4,9 | | |
| | | | | | | 125 | | 8,5 | | |
| | | | | | | 150 | | 9,35 | | mWs |



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|-----------|-----------|------------|-----|-----|------|
| | | V_{GE} [V] | V_{GS} [V] | V_{CE} [V] | V_{DS} [V] | I_C [A] | I_D [A] | T_j [°C] | Min | Typ | Max |

Outer Boost Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|----------------|--|--|----|------------------|--|----------------------|------------------|---------|
| Forward voltage | V_F | | | | 80 | 25 125 150 | | 1,37 1,56 1,63 | 2 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_r = 1200$ V | | | | 25 | | 20 | 2000 | μ A |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,41 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|----------------------------------------------------------------------------------|----------|-----|-----|------------------|--|----------------------------------|--|-----------|
| Peak recovery current | I_{RM} | $di/dt=12410$ A/ μ s $di/dt=12064$ A/ μ s $di/dt=11035$ A/ μ s | ± 15 | 700 | 200 | 25 125 150 | | 83,94 84,02 84,41 | | A |
| Reverse recovery time | t_{rr} | | | | | 25 125 150 | | 14,59 14,99 15,17 | | ns |
| Recovered charge | Q_r | | | | | 25 125 150 | | 0,725 0,736 0,747 | | μ C |
| Reverse recovered energy | E_{rec} | | ± 15 | 700 | 200 | 25 125 150 | | 0,105 0,111 0,113 | | mWs |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | | | | | 25 125 150 | | 17742,76 17838,91 17343,81 | | A/μ s |



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datasheet

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Characteristic Values

| Parameter | Symbol | Conditions | | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|-----------|-----------|------------|-----|-----|------|
| | | V_{GE} [V] | V_{GS} [V] | V_{CE} [V] | V_{DS} [V] | I_C [A] | I_D [A] | T_j [°C] | Min | Typ | Max |

Outer Boost Sw. Protection Diode

Static

| | | | | | | | | | | |
|-------------------------|-------|----------------|--|--|----|------------------|--|------------------------|--------------------|----|
| Forward voltage | V_F | | | | 40 | 25 125 150 | | 1,06 0,987 0,974 | 1,5 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_r = 1600$ V | | | | 25 150 | | | 100 2000 | μA |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,76 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Aux Diode H

Static

| | | | | | | | | | | |
|-------------------------|-------|----------------|--|--|----|------------------|--|----------------------|--------------------|----|
| Forward voltage | V_F | | | | 75 | 25 125 150 | | 2,59 2,16 2,07 | 3,3 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_r = 1200$ V | | | | 25 150 | | | 250 2000 | μA |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,66 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|



Vincotech

Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|--------------|--------------|--------------|--------------|-----------|------------|-----|-----|------|
| | | V_{GE} [V] | V_{GS} [V] | V_{CE} [V] | V_{DS} [V] | I_C [A] | T_j [°C] | Min | Typ | Max |
| | | | | | | | | | | |

Aux Diode L

Static

| | | | | | | | | | | |
|-------------------------|-------|----------------|--|--|----|------------------|--|----------------------|--------------------|----|
| Forward voltage | V_F | | | | 75 | 25 125 150 | | 2,59 2,16 2,07 | 3,3 ⁽¹⁾ | V |
| Reverse leakage current | I_R | $V_F = 1200$ V | | | | 25 150 | | | 250 2000 | µA |

Thermal

| | | | | | | | | | | |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,66 | | K/W |
|----------------------------------------------------|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Thermistor

Static

| | | | | | | | | | | |
|--------------------------------|----------------|--------------------|--|--|--|-----|----|------|---|------|
| Rated resistance | R | | | | | 25 | | 22 | | kΩ |
| Deviation of R100 | $A_{R/R}$ | $R_{100} = 1484$ Ω | | | | 100 | -5 | | 5 | % |
| Power dissipation | P | | | | | 25 | | 130 | | mW |
| Power dissipation constant | d | | | | | 25 | | 1,5 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. ±1 % | | | | | | 3962 | | K |
| B-value | $B_{(25/100)}$ | Tol. ±1 % | | | | | | 4000 | | K |
| Vincotech Thermistor Reference | | | | | | | | I | | |

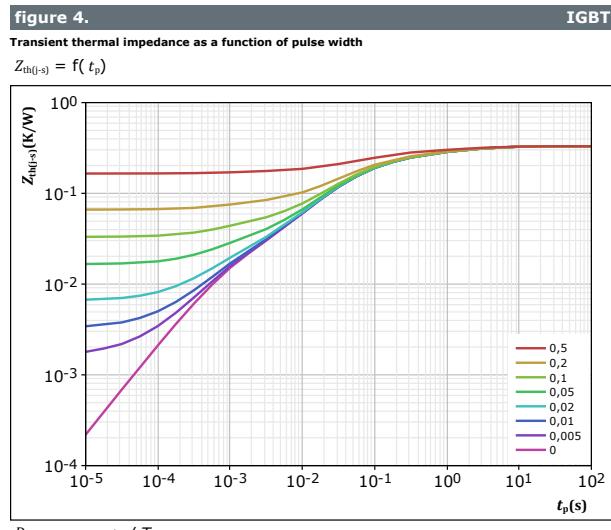
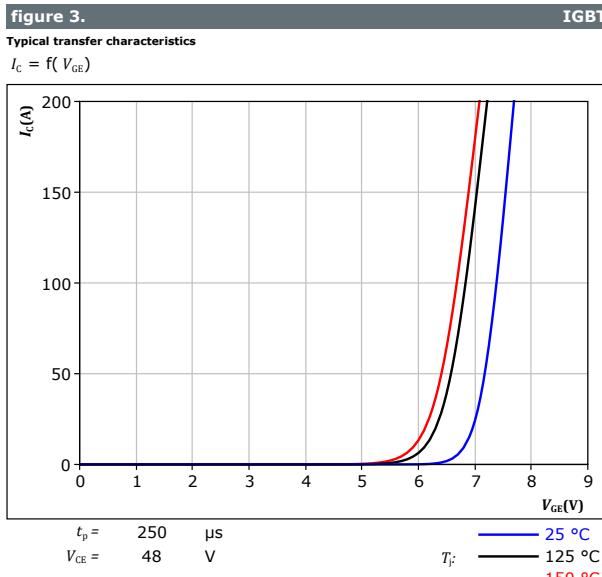
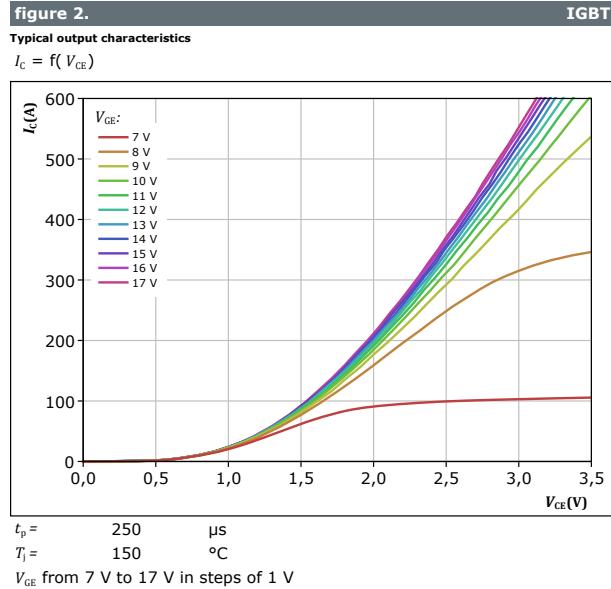
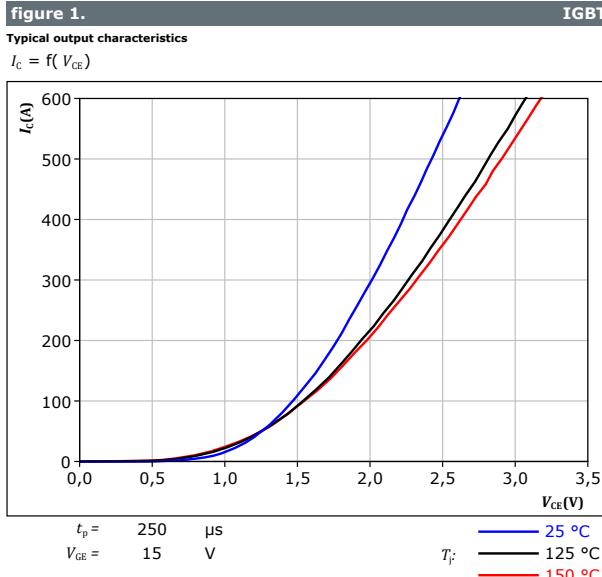
⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Vincotech

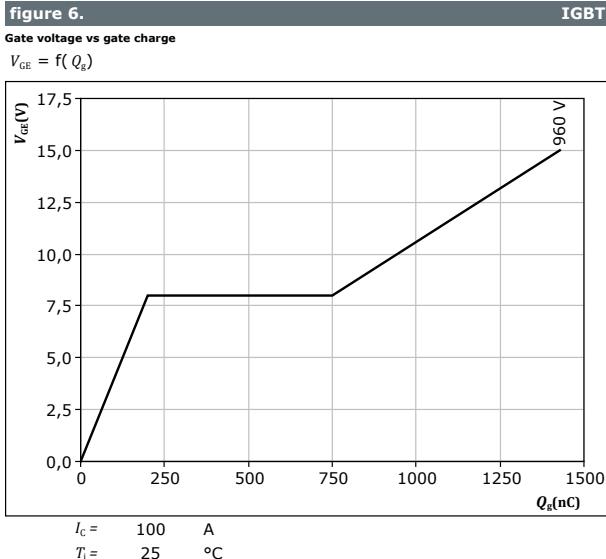
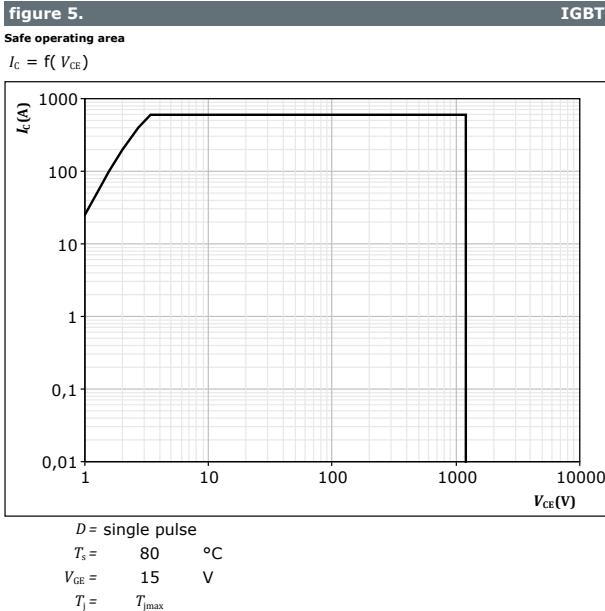
Inner Boost Switch Characteristics



| $D = R_{th(t-s)} / t_p / T$ | t_p / T | K/W |
|-----------------------------|------------|-----|
| IGBT thermal model values | | |
| R (K/W) | τ (s) | |
| 3,72E-02 | 4,28E+00 | |
| 7,68E-02 | 6,09E-01 | |
| 1,42E-01 | 7,68E-02 | |
| 6,11E-02 | 1,66E-02 | |
| 1,38E-02 | 8,44E-04 | |

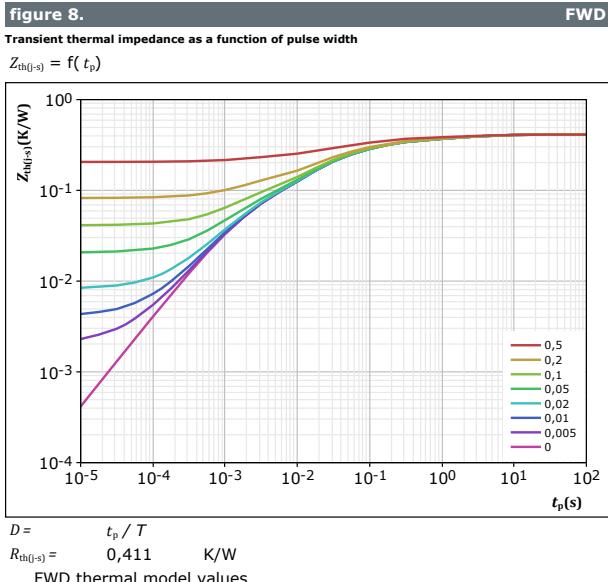
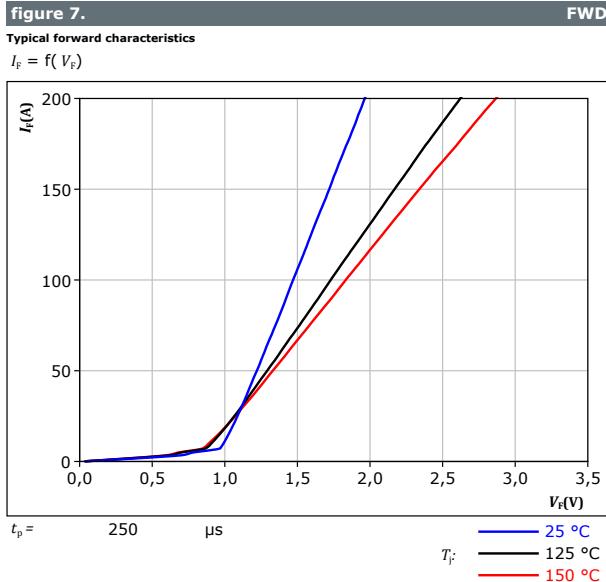


Inner Boost Switch Characteristics



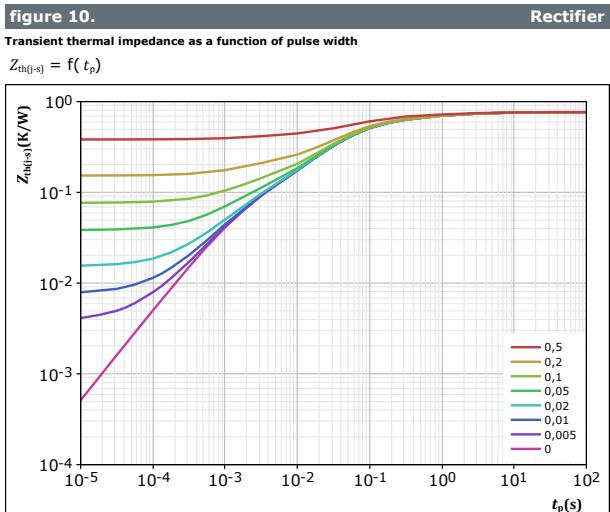
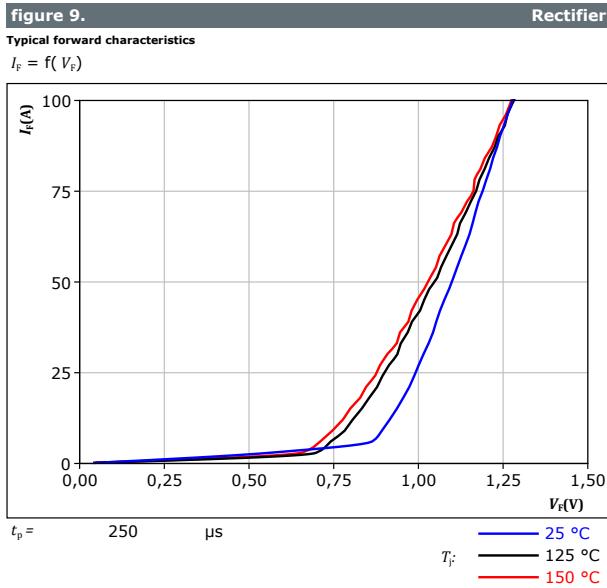


Inner Boost Diode Characteristics





Inner Boost Sw. Protection Diode Characteristics





Outer Boost Switch Characteristics

figure 11. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

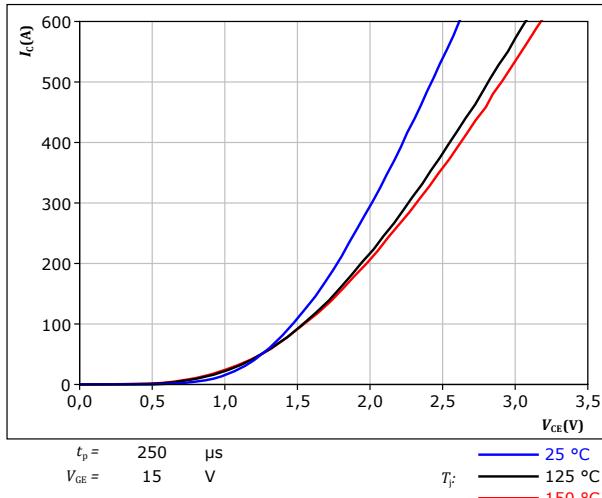


figure 13. IGBT

Typical transfer characteristics
 $I_C = f(V_{GE})$

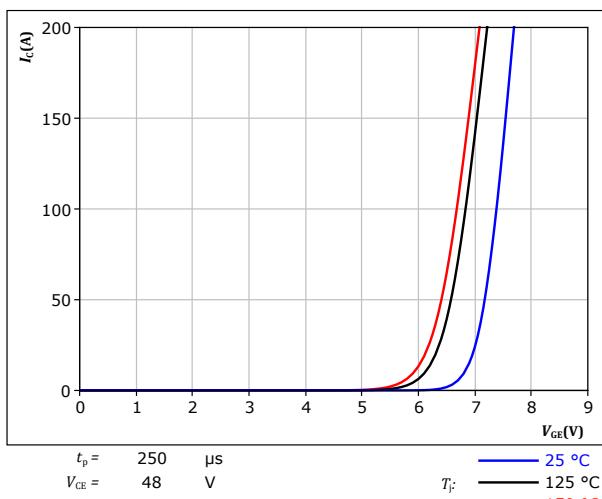


figure 12. IGBT

Typical output characteristics
 $I_C = f(V_{CE})$

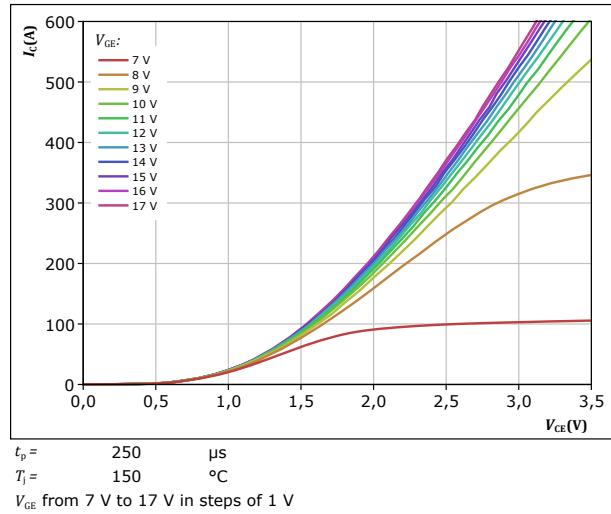
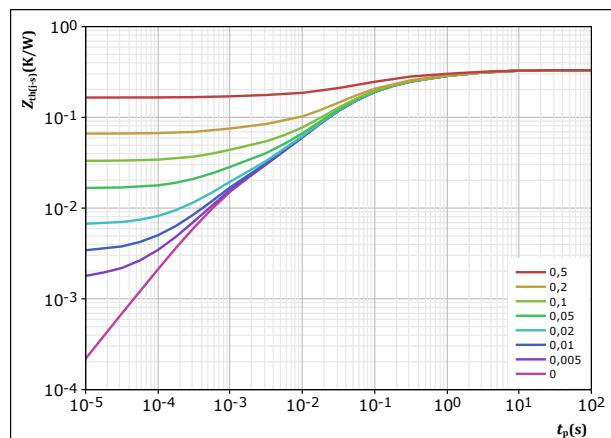


figure 14. IGBT

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



$$D = \frac{t_p}{T} \quad R_{th(j-s)} = \frac{0,331}{t_p / T} \quad K/W$$

IGBT thermal model values

| R (K/W) | τ (s) |
|-----------|------------|
| 3,72E-02 | 4,28E+00 |
| 7,68E-02 | 6,09E-01 |
| 1,42E-01 | 7,68E-02 |
| 6,11E-02 | 1,66E-02 |
| 1,38E-02 | 8,44E-04 |



Outer Boost Switch Characteristics

figure 15.

Safe operating area

$$I_C = f(V_{CE})$$

IGBT

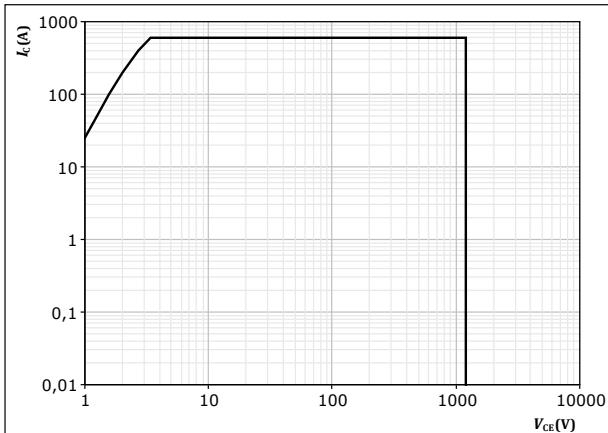
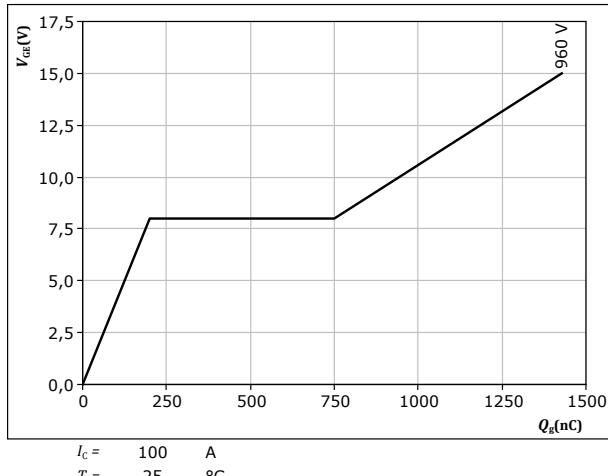


figure 16.

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$

IGBT





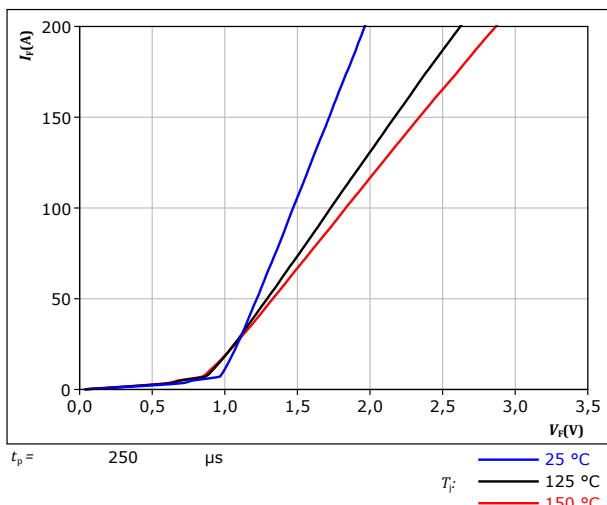
Outer Boost Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

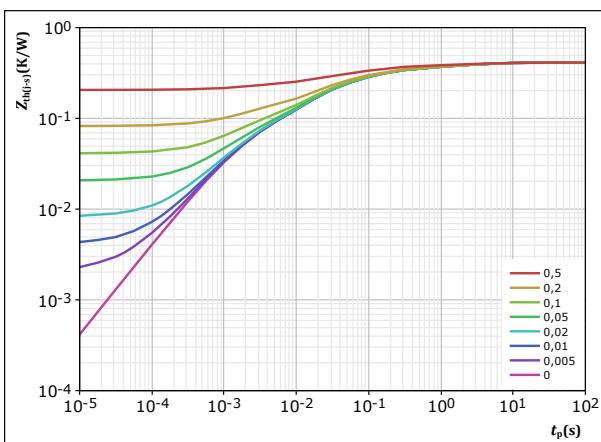
T_F :
— 25 °C
— 125 °C
— 150 °C

figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(t-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} \quad R_{th(t-s)} = 0,411 \text{ K/W}$$

FWD thermal model values

| R (K/W) | τ (s) |
|-----------|------------|
| 3,61E-02 | 4,15E+00 |
| 4,65E-02 | 7,98E-01 |
| 1,31E-01 | 1,00E-01 |
| 1,47E-01 | 1,86E-02 |
| 5,10E-02 | 1,58E-03 |



Outer Boost Sw. Protection Diode Characteristics

figure 19.

Typical forward characteristics

$$I_F = f(V_F)$$

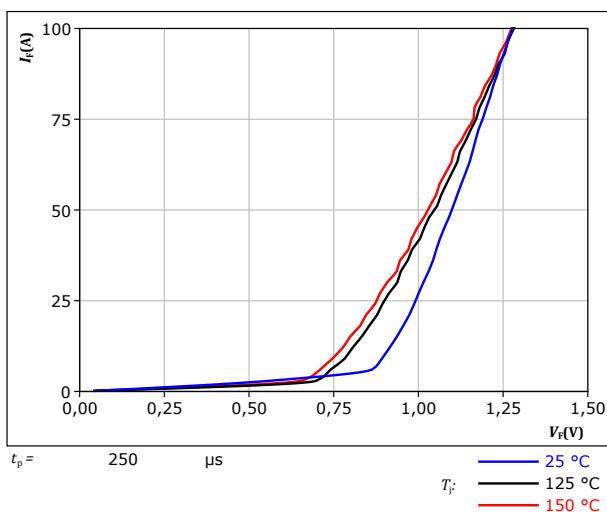
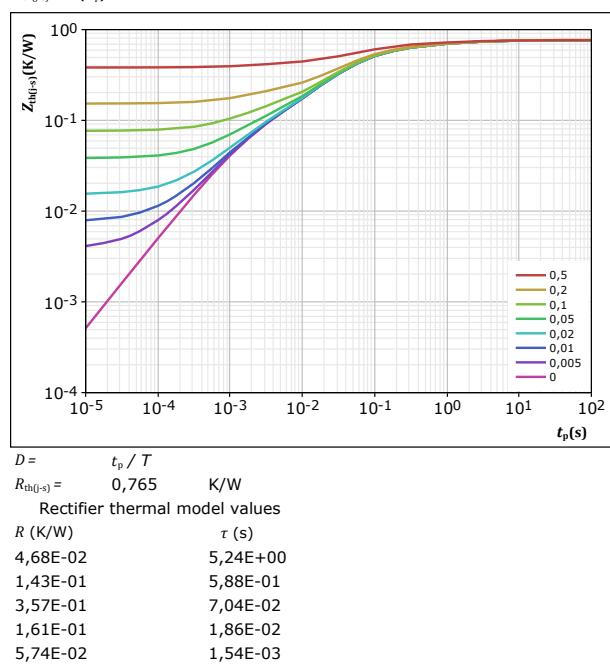


figure 20.

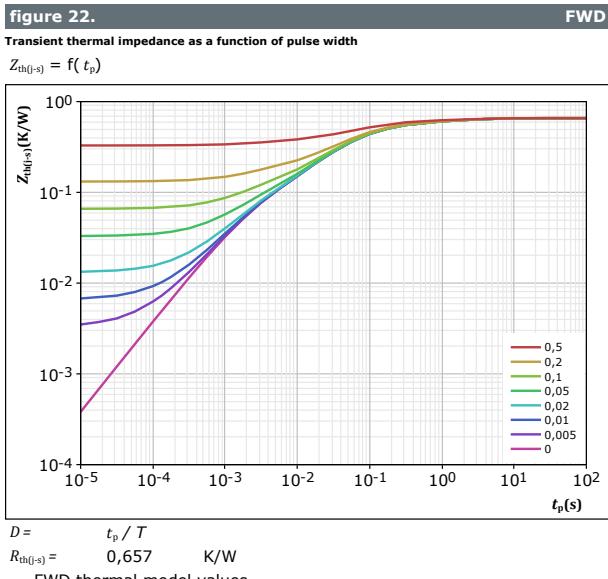
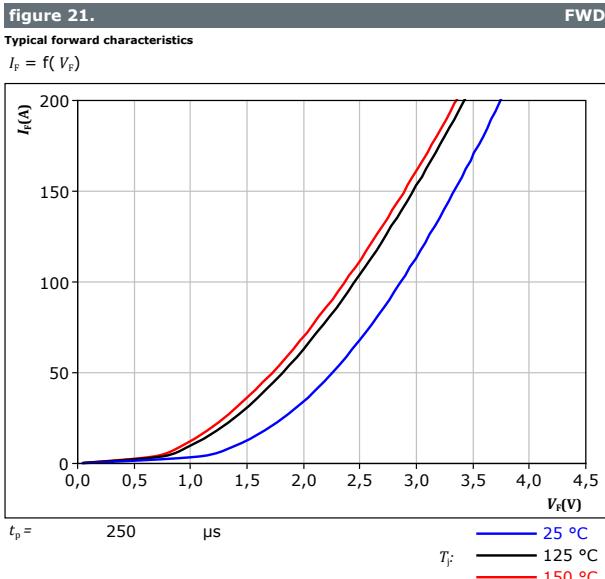
Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



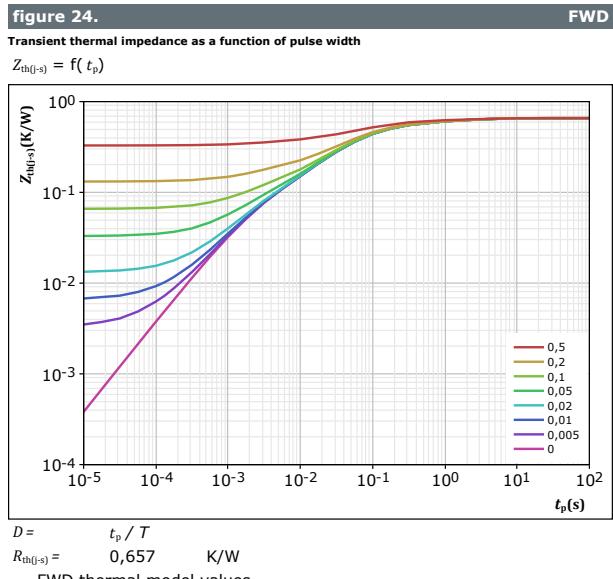
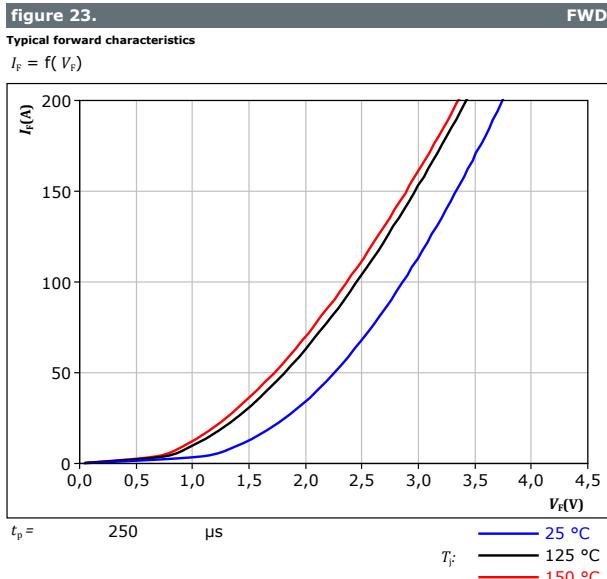


Aux Diode H Characteristics



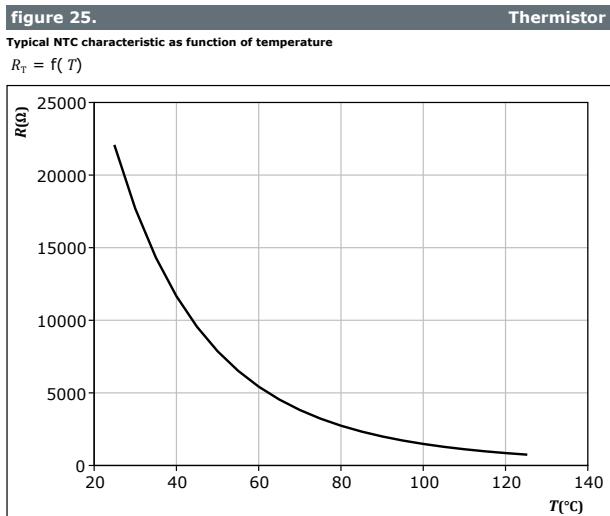


Aux Diode L Characteristics





Thermistor Characteristics



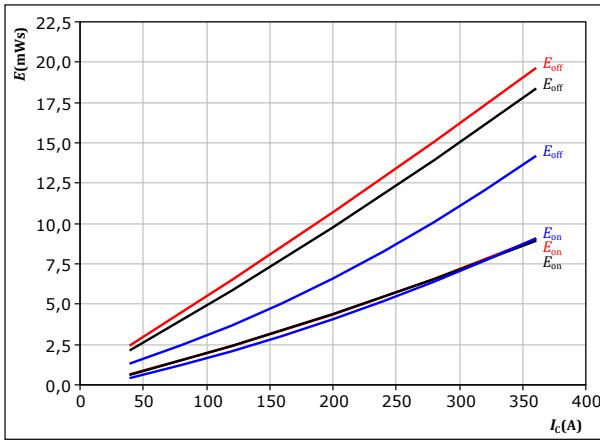


Inner Boost Switching Characteristics

figure 26. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

| | | |
|--------------|----------|----------|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $R_{gon} =$ | 2 | Ω |
| $R_{goff} =$ | 2 | Ω |

$T_f:$

125 °C

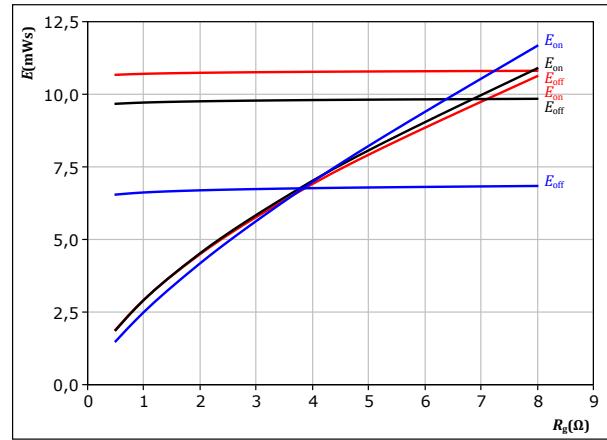
150 °C

IGBT

figure 27. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

| | | |
|------------|----------|---|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $I_c =$ | 200 | A |

$T_f:$

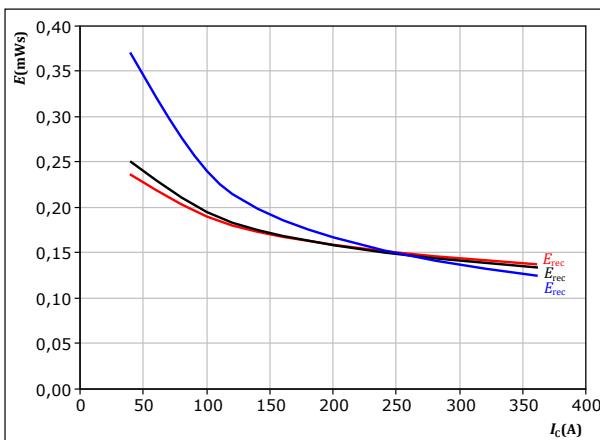
125 °C

150 °C

figure 28. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

| | | |
|-------------|----------|----------|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $R_{gon} =$ | 2 | Ω |

$T_f:$

125 °C

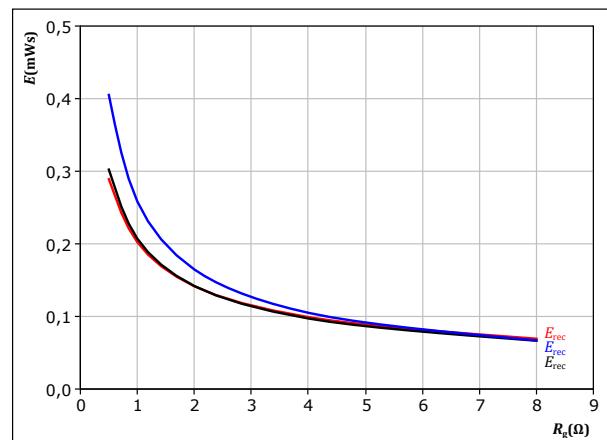
150 °C

FWD

figure 29. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

| | | |
|------------|----------|---|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $I_c =$ | 200 | A |

$T_f:$

125 °C

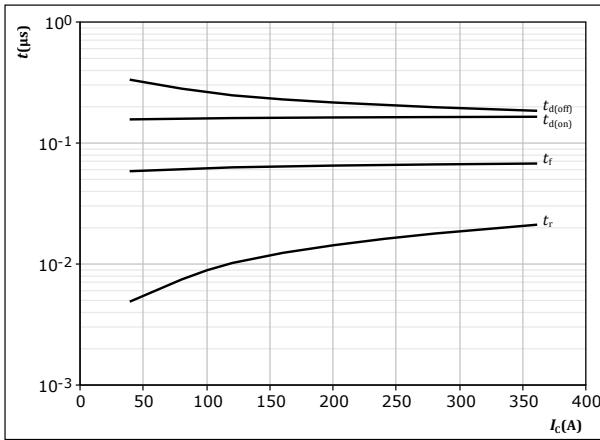
150 °C



Inner Boost Switching Characteristics

figure 30. IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

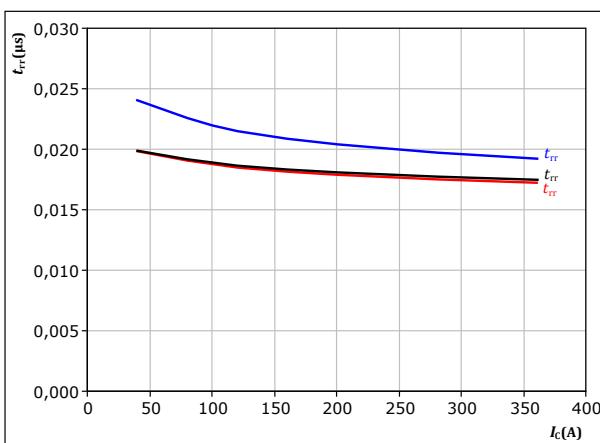


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 2 \Omega$

figure 32. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$

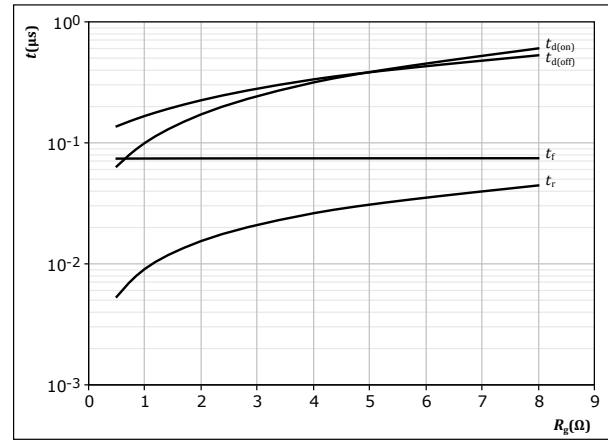


With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$

figure 31. IGBT

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$

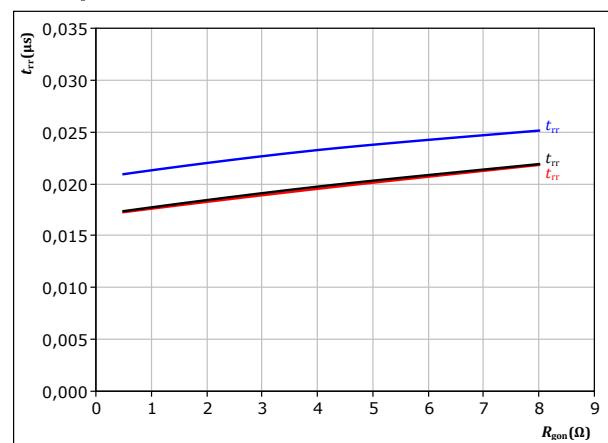


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 200 \text{ A}$

figure 33. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 200 \text{ A}$



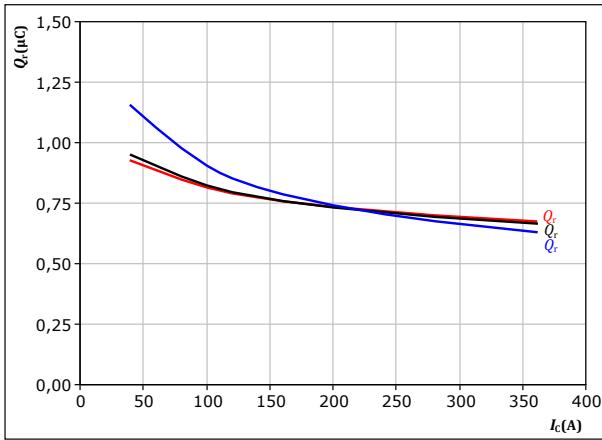
Vincotech

Inner Boost Switching Characteristics

figure 34.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

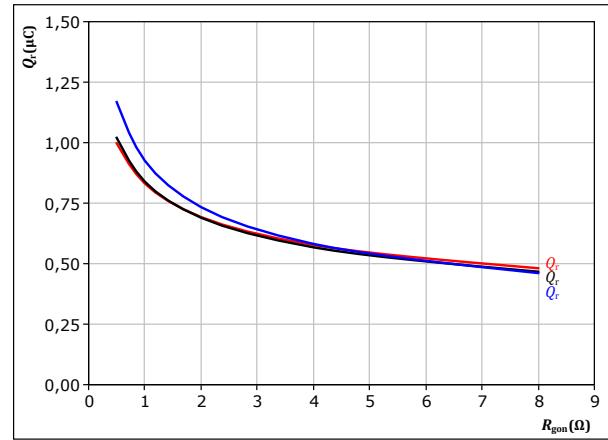
$$\begin{aligned} T_f &= 125 \text{ °C} \\ I_c &= 200 \text{ A} \end{aligned}$$

FWD

figure 35.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

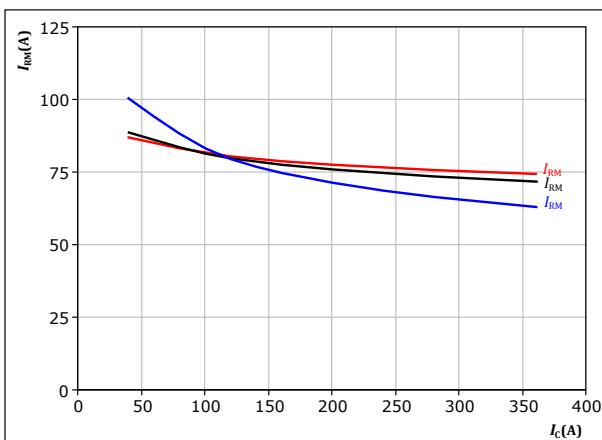
$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 200 \text{ A} \end{aligned}$$

FWD

figure 36.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

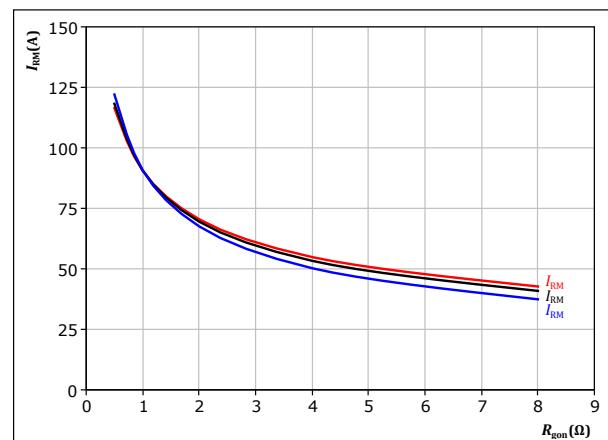
$$\begin{aligned} T_f &= 125 \text{ °C} \\ I_c &= 200 \text{ A} \end{aligned}$$

FWD

figure 37.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 200 \text{ A} \end{aligned}$$

FWD

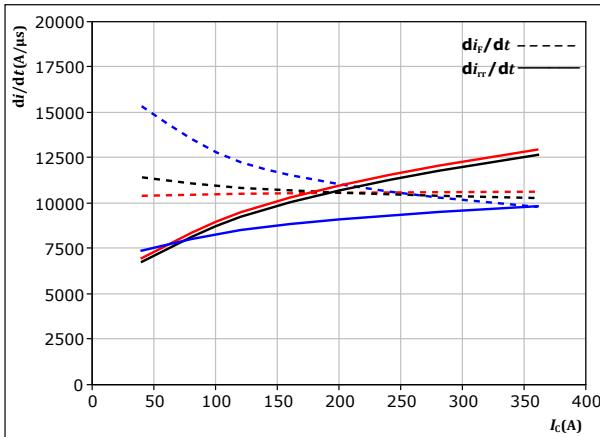


Vincotech

Inner Boost Switching Characteristics

figure 38. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



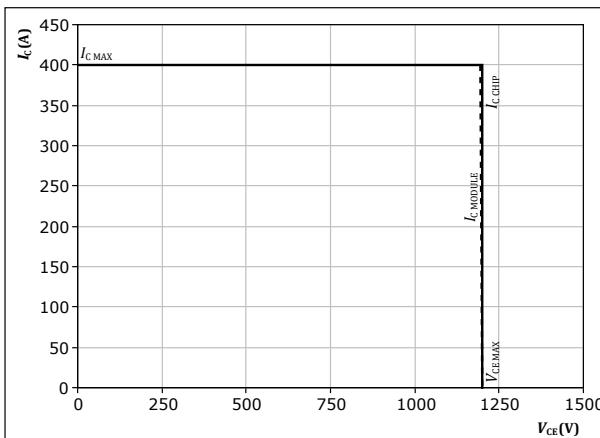
With an inductive load at

$V_{CE} = 700$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $R_{gon} = 2$ Ω $T_j = 150^\circ\text{C}$

figure 40. IGBT

Reverse bias safe operating area

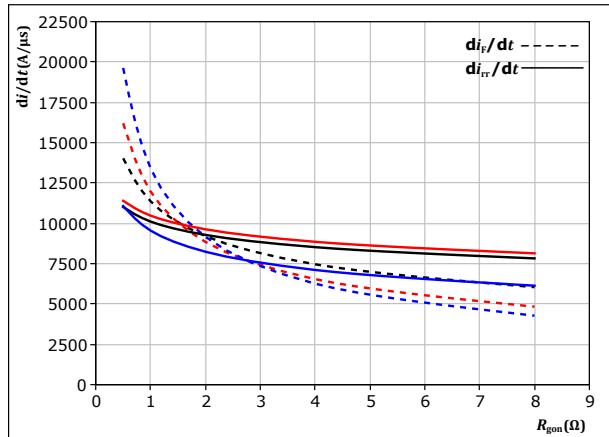
$I_c = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω

figure 39. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at
 $V_{CE} = 700$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $I_c = 200$ A $T_j = 150^\circ\text{C}$



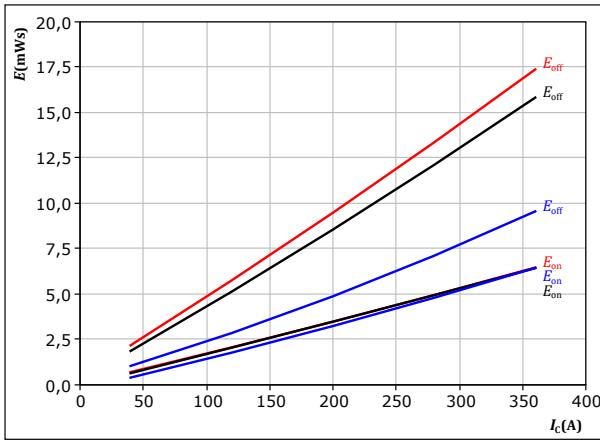
Vincotech

Outer Boost Switching Characteristics

figure 41. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

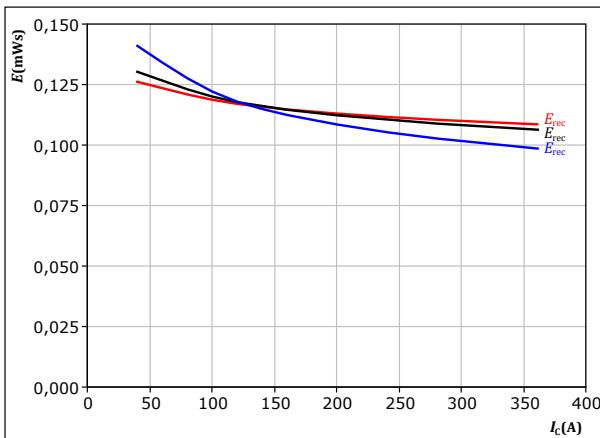
| | | |
|--------------|----------|----------|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $R_{gon} =$ | 2 | Ω |
| $R_{goff} =$ | 2 | Ω |

$T_f:$ — 25 °C — 125 °C — 150 °C

figure 43. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

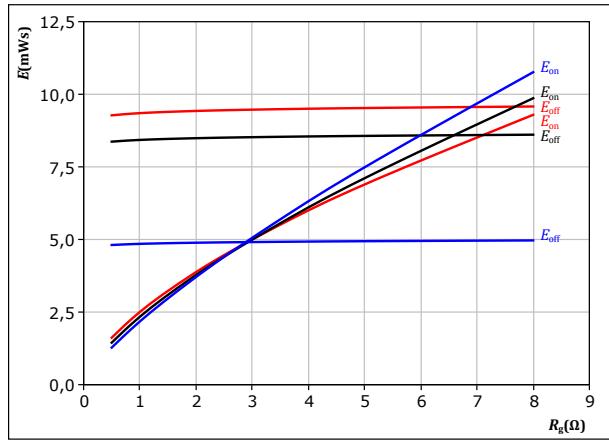
| | | |
|-------------|----------|----------|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $R_{gon} =$ | 2 | Ω |

$T_f:$ — 25 °C — 125 °C — 150 °C

figure 42. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

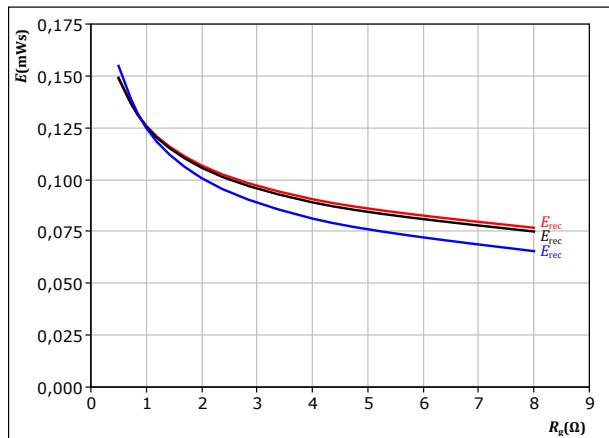
| | | |
|------------|----------|---|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $I_c =$ | 200 | A |

$T_f:$ — 25 °C — 125 °C — 150 °C

figure 44. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

| | | |
|------------|----------|---|
| $V_{CE} =$ | 700 | V |
| $V_{GE} =$ | ± 15 | V |
| $I_c =$ | 200 | A |

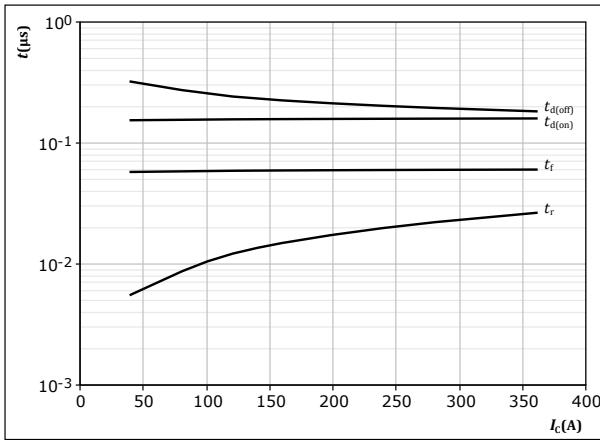
$T_f:$ — 25 °C — 125 °C — 150 °C



Outer Boost Switching Characteristics

figure 45. IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

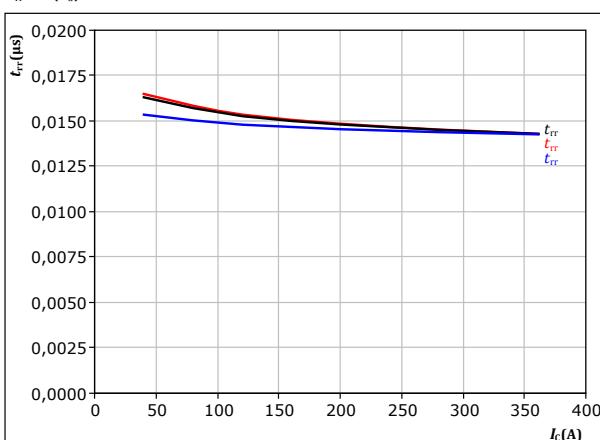


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$
 $R_{goff} = 2 \Omega$

figure 47. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$

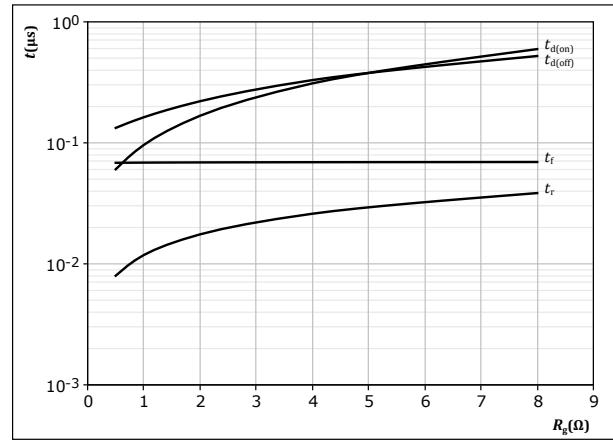


With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 2 \Omega$

figure 46. IGBT

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$

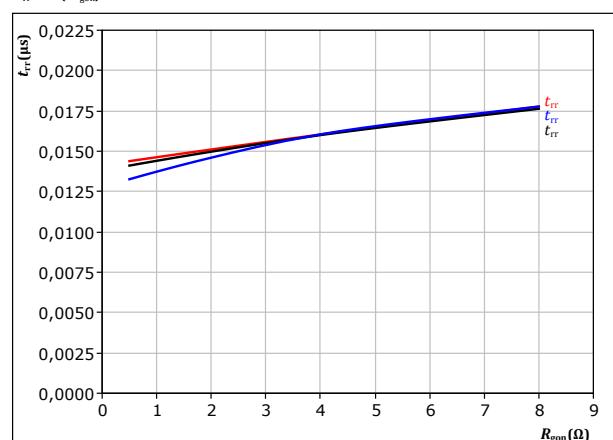


With an inductive load at

$T_j = 150^\circ\text{C}$
 $V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 200 \text{ A}$

figure 48. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 700 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 200 \text{ A}$



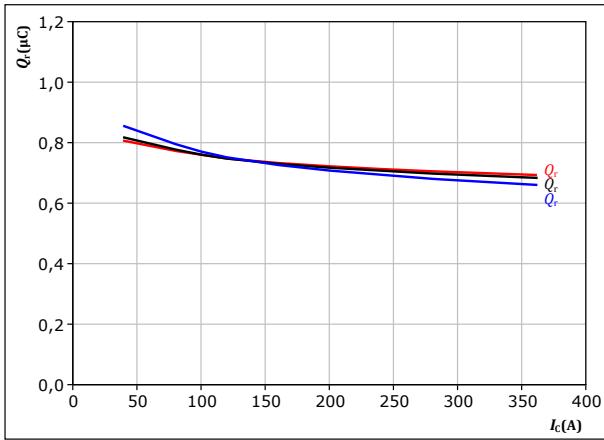
Outer Boost Switching Characteristics

figure 49.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

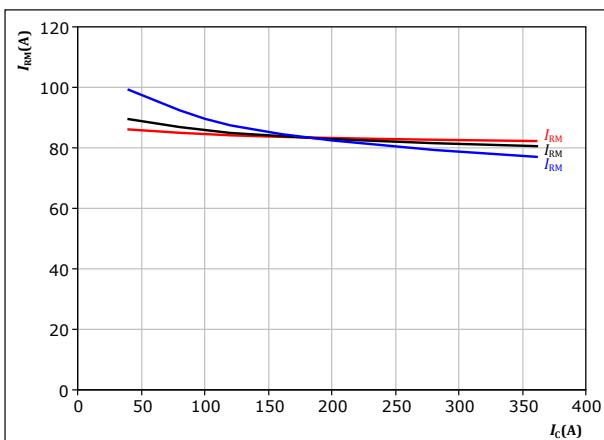
$$\begin{aligned} T_f &= 125 \text{ }^{\circ}\text{C} \\ I_c &= 200 \text{ A} \end{aligned}$$

figure 51.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 700 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

$$\begin{aligned} T_f &= 125 \text{ }^{\circ}\text{C} \\ I_c &= 200 \text{ A} \end{aligned}$$

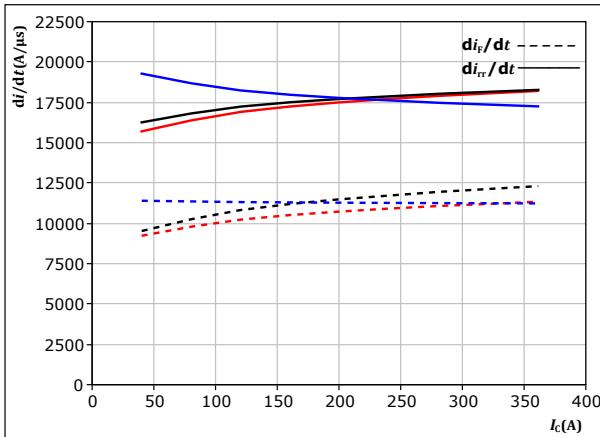


Vincotech

Outer Boost Switching Characteristics

figure 53. FWD

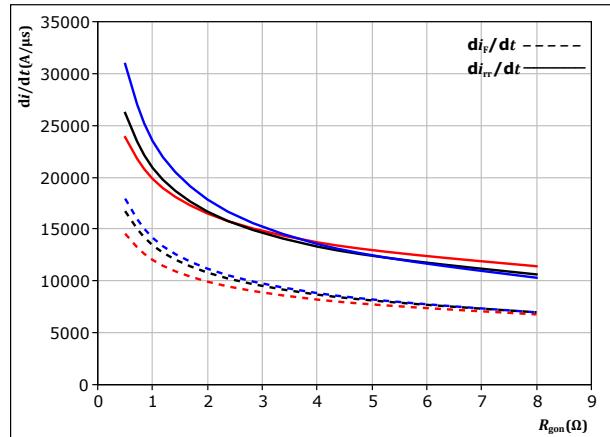
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at
 $V_{CE} = 700$ V $T_j = 25^\circ C$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ C$
 $R_{gon} = 2$ Ω $T_j = 150^\circ C$

figure 54. FWD

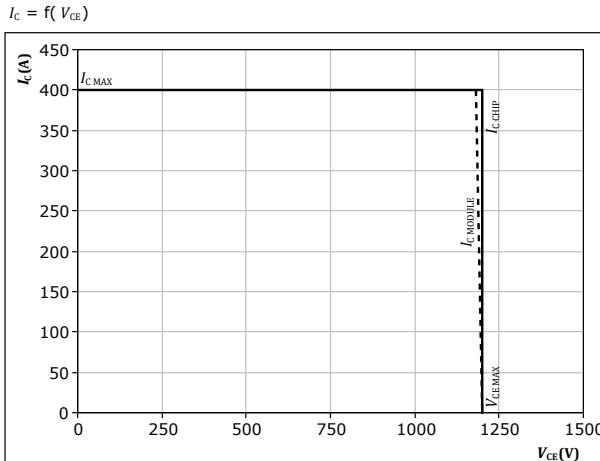
Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at
 $V_{CE} = 700$ V $T_j = 25^\circ C$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ C$
 $I_c = 200$ A $T_j = 150^\circ C$

figure 55. IGBT

Reverse bias safe operating area
 $I_c = f(V_{CE})$



At $T_j = 150$ $^\circ C$
 $R_{gon} = 2$ Ω
 $R_{goff} = 2$ Ω



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Switching Definitions

figure 56. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

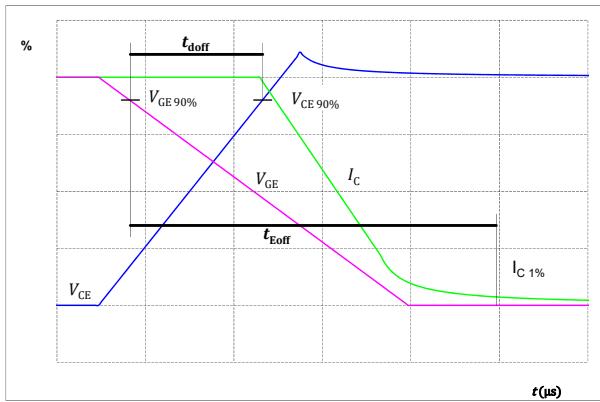


figure 57. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

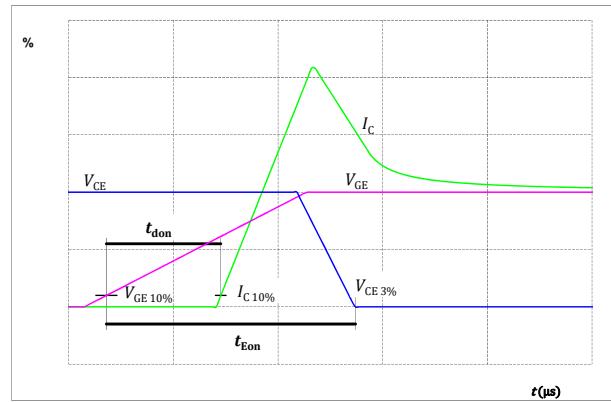


figure 58. IGBT

Turn-off Switching Waveforms & definition of t_f

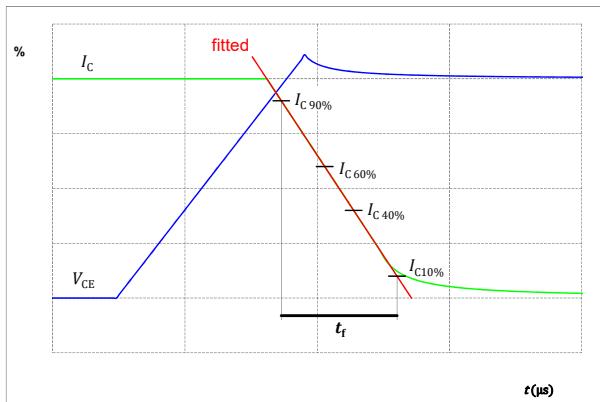
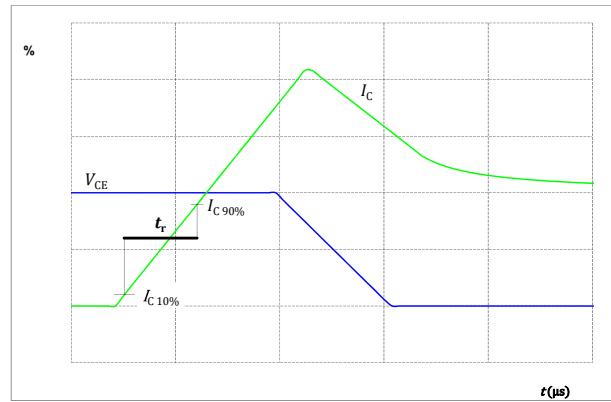


figure 59. IGBT

Turn-on Switching Waveforms & definition of t_r





Switching Definitions

figure 60.
Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

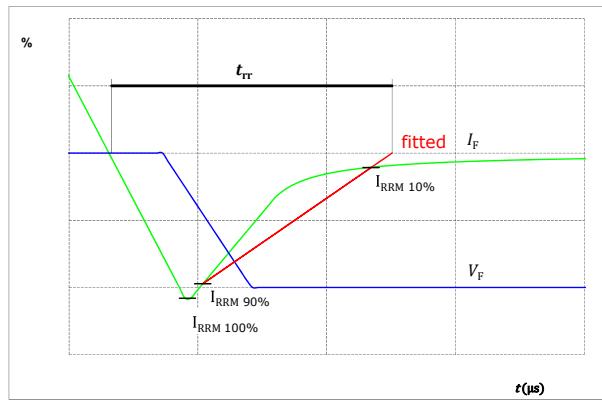
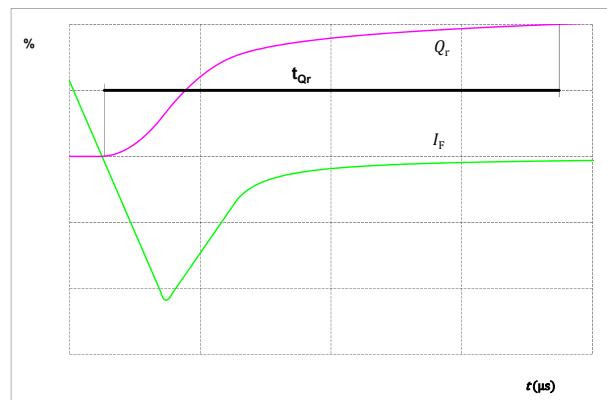


figure 61.
Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

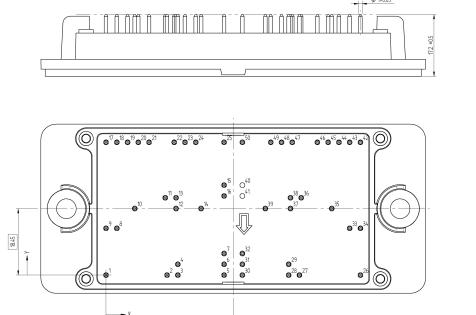


**30-FT12B2A200H705-PK49L06**

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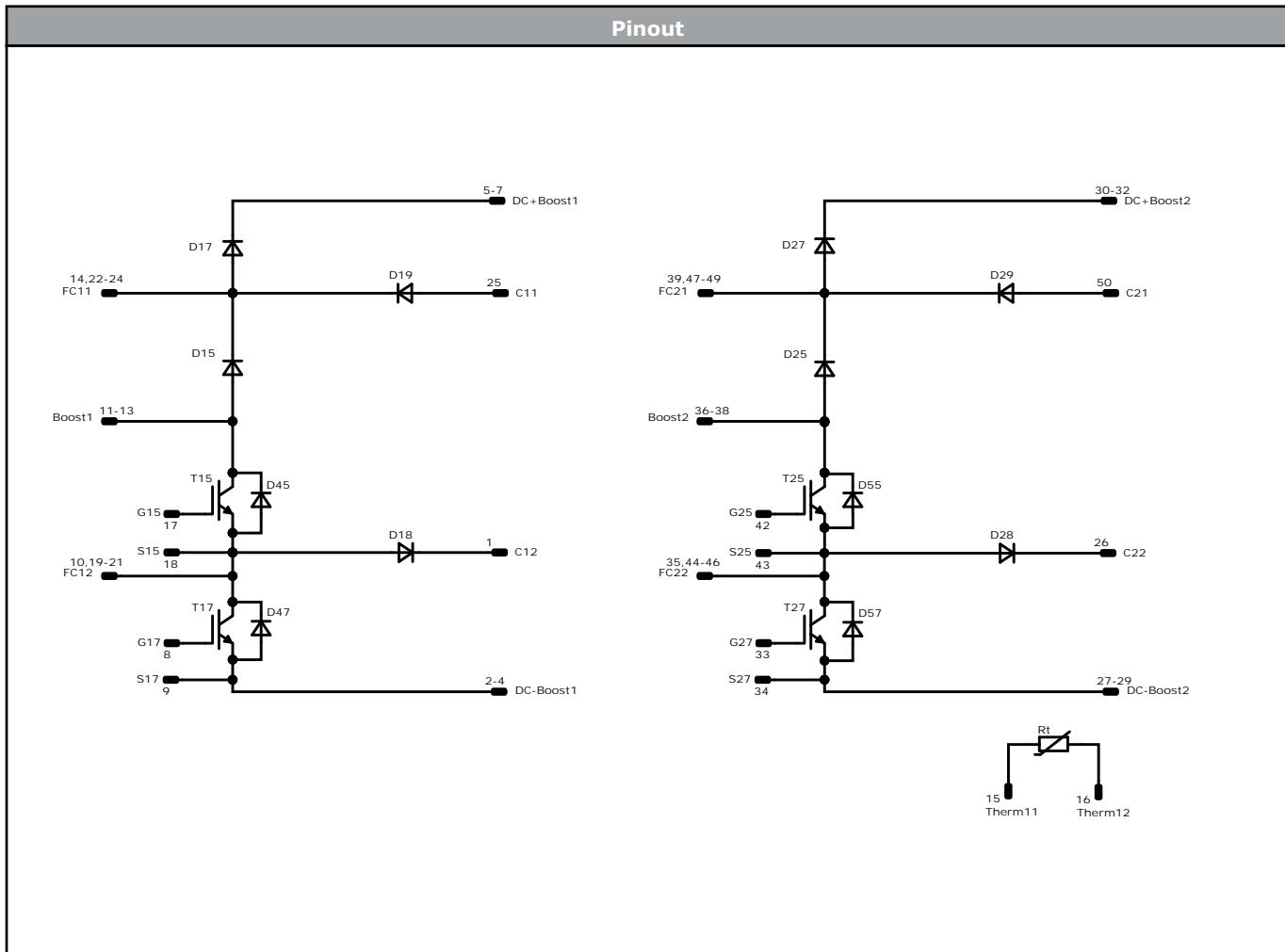
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| Ordering Code | | | | | | | |
|---------------------------------------|------|------------|--------------------------------|-------------------------------|---------------|-----------|---------------|
| Version | | | | Ordering Code | | | |
| Without thermal paste | | | | 30-FT12B2A200H705-PK49L06 | | | |
| With thermal paste (3,4 W/mK, PSX-P7) | | | | 30-FT12B2A200H705-PK49L06-/3/ | | | |
| Marking | | | | | | | |
| | | Text | Name | Date code | UL & VIN | Lot | Serial |
| | | | NN-NNNNNNNNNNNNNN- TTTTTTVV | WWYY | UL VIN | LLLLL | SSSS |
| | | Datamatrix | Type&Ver | Lot number | Serial | Date code | |
| | | | TTTTTTVV | LLLLL | SSSS | WWYY | |
| Outline | | | | | | | |
| Pin table [mm] | | | | | | | |
| Pin | X | Y | Function | 26 | 70,9 | 0 | C22 |
| 1 | 0 | 0 | C12 | 27 | 53,9 | 0 | DC- Boost2 |
| 2 | 17 | 0 | DC- Boost1 | 28 | 50,9 | 0 | DC- Boost2 |
| 3 | 20 | 0 | DC- Boost1 | 29 | 50,9 | 3 | DC- Boost2 |
| 4 | 20 | 3 | DC- Boost1 | 30 | 38 | 0 | DC+Boost2 |
| 5 | 32,9 | 0 | DC+Boost1 | 31 | 38 | 3 | DC+Boost2 |
| 6 | 32,9 | 3 | DC+Boost1 | 32 | 38 | 6 | DC+Boost2 |
| 7 | 32,9 | 6 | DC+Boost1 | 33 | 67,9 | 13 | G27 |
| 8 | 3 | 13 | G17 | 34 | 70,9 | 13 | S27 |
| 9 | 0 | 13 | S17 | 35 | 62,9 | 18,5 | FC22 |
| 10 | 8 | 18,5 | FC12 | 36 | 54,4 | 21,5 | Boost2 |
| 11 | 16,5 | 21,5 | Boost1 | 37 | 51,4 | 18,5 | Boost2 |
| 12 | 19,5 | 18,5 | Boost1 | 38 | 51,4 | 21,5 | Boost2 |
| 13 | 19,5 | 21,5 | Boost1 | 39 | 44,4 | 18,5 | FC21 |
| 14 | 26,5 | 18,5 | FC11 | 40 | not assembled | | |
| 15 | 32,9 | 25 | Therm11 | 41 | not assembled | | |
| 16 | 32,9 | 22 | Therm12 | 42 | 70,9 | 36,9 | G25 |
| 17 | 0 | 36,9 | G15 | 43 | 67,9 | 36,9 | S25 |
| 18 | 3 | 36,9 | S15 | 44 | 64,9 | 36,9 | FC22 |
| 19 | 6 | 36,9 | FC12 | 45 | 61,9 | 36,9 | FC22 |
| 20 | 9 | 36,9 | FC12 | 46 | 58,9 | 36,9 | FC22 |
| 21 | 12 | 36,9 | FC12 | 47 | 51,9 | 36,9 | FC21 |
| 22 | 19 | 36,9 | FC11 | 48 | 48,9 | 36,9 | FC21 |
| 23 | 22 | 36,9 | FC11 | 49 | 45,9 | 36,9 | FC21 |
| 24 | 25 | 36,9 | FC11 | 50 | 38 | 36,9 | C21 |
| 25 | 32,9 | 36,9 | C11 | | | | |





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Identification

| ID | Component | Voltage | Current | Function | Comment |
|----------|------------|---------|---------|----------------------------------|---------|
| T15, T25 | IGBT | 1200 V | 200 A | Inner Boost Switch | |
| D15, D25 | FWD | 1200 V | 80 A | Inner Boost Diode | |
| D45, D55 | Rectifier | 1600 V | 40 A | Inner Boost Sw. Protection Diode | |
| T17, T27 | IGBT | 1200 V | 200 A | Outer Boost Switch | |
| D17, D27 | FWD | 1200 V | 80 A | Outer Boost Diode | |
| D47, D57 | Rectifier | 1600 V | 40 A | Outer Boost Sw. Protection Diode | |
| D19, D29 | FWD | 1200 V | 75 A | Aux Diode H | |
| D18, D28 | FWD | 1200 V | 75 A | Aux Diode L | |
| Rt | Thermistor | | | Thermistor | |

**30-FT12B2A200H705-PK49L06**

datasheet

Vincotech**Packaging instruction**

| | | | | |
|--------------------------------------|------|----------|------|--------|
| Standard packaging quantity (SPQ) 36 | >SPQ | Standard | <SPQ | Sample |
|--------------------------------------|------|----------|------|--------|

Handling instruction

Handling instructions for flow 2 packages see vincotech.com website.

Package data

Package data for flow 2 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

Application Note

For use of pre-charging auxiliary diodes see application note: "The Advantages and Operation of Flying-Capacitor Boosters" at vincotech.com

UL recognition and file number

This device is UL 1557 recognized under E192116 up to a junction temperature under switching condition $T_{j,\text{op}}=175^{\circ}\text{C}$ and up to 4000VAC/1min isolation voltage. For more information see vincotech.com website.



| Document No.: | Date: | Modification: | Pages |
|---------------------------------|-------------|-----------------|-------|
| 30-FT12B2A200H705-PK49L06-D1-14 | 6 Aug. 2024 | Initial Release | |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.